

### 34mm Half Bridge IGBT Module

$V_{CES} = 1200V$ ,  $I_C = 75A$ ,  $V_{CE(sat)} = 2.05V$

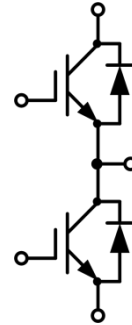
#### Features

- 1200V Trench/Field Stop Technology
- Low switching losses
- $V_{cesat}$  has a positive temperature coefficient



#### Applications

- Inverter Welding Machine
- Induction Heating
- High Frequency Switching
- Inverter



#### IGBT, Inverter Maximum Ratings

Parameter	Symbol	Test Condition	Value	Unit
Collector-Emitter voltage	$V_{CES}$	$T_{vj}=25^{\circ}C$	1200	V
Continuous DC collector current	$I_{C\ nom}$	$T_C=100^{\circ}C$ , $T_{vj\ max}=175^{\circ}C$	75	A
Repetitive peak collector current	$I_{CRM}$	$t_p=1ms$	150	A
Gate emitter voltage	$V_{GE}$		$\pm 20$	V

#### Characteristics Values

Parameter	Symbol	Test Condition	Value			Unit
			Min.	Typ.	Max.	
Collector-Emitter saturation voltage	$V_{CESat}$	$V_{GE}=15V$ , $I_C=75A$ $V_{GE}=15V$ , $I_C=75A$ $V_{GE}=15V$ , $I_C=75A$	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	2.05 2.45 2.56	2.5	V
Gate-Emitter threshold voltage	$V_{GE(th)}$	$I_C=2.6mA$ , $V_{GE}=V_{CE}$	$T_{vj}=25^{\circ}C$	5.00	5.7	6.3
Gate charge	$Q_G$	$V_{GE}=-15V \dots +15V$		0.63		$\mu C$
Internal gate resistor	$R_{Gint}$			None		$\Omega$
Input capacitance	$C_{ies}$	$f=100kHz$ , $V_{CE}=25V$ , $V_{GE}=0V$	$T_{vj}=25^{\circ}C$	8.37		nF
Output capacitance	$C_{oes}$			0.35		
Reverse transfer capacitance	$C_{res}$			0.13		
Collector-emitter cut-off current	$I_{CES}$	$V_{CE}=1200V$ , $V_{GE}=0V$	$T_{vj}=25^{\circ}C$		1	mA
Gate-emitter leakage current	$I_{GES}$	$V_{CE}=0V$ , $V_{GE}=20V$	$T_{vj}=25^{\circ}C$		100	nA
Turn-on delay time	$t_{d\ on}$	$I_C=60A$ , $V_{CE}=600V$ $V_{GE}=\pm 15V$ , $R_G=15\Omega$ (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	77 75 70		ns

Rise time	$t_r$	$I_C=60A, V_{CE}=600V$ $V_{GE}=15V, R_G=15\Omega$ (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$		65 59 57		
Turn-off delay time	$t_{d\ off}$	$I_C=60A, V_{CE}=600V$ $V_{GE}=\pm 15V, R_G=15\Omega$ (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$		228 237 244		ns
Fall time	$t_f$	$I_C=60A, V_{CE}=600V$ $V_{GE}=\pm 15V, R_G=15\Omega$ (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$		68 155 157		
Turn-on energy loss per pulse	$E_{on}$	$I_C=60A, V_{CE}=600V$ $V_{GE}=\pm 15V, R_G=15\Omega$ (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$		3.68 5.18 5.85		mJ
Turn-off energy loss per pulse	$E_{off}$	$I_C=60A, V_{CE}=600V$ $V_{GE}=\pm 15V, R_G=15\Omega$ (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$		2.19 2.69 2.84		
Thermal resistance, junction to case	$R_{thJC}$	per IGBT				0.42	K/W
Temperature under switching conditions	$T_{vj\ op}$			-40		150	$^\circ C$

### Diode, Inverter Maximum Ratings

Parameter	Symbol	Test Condition	Value	Unit
Repetitive peak reverse voltage	$V_{RRM}$	$T_{vj}=25^\circ C$	1200	V
Continuous DC forward current	$I_F$		60	A
Repetitive peak forward current	$I_{FRM}$	$t_p=1ms$	120	A
$I^2t$ -value	$I^2t$	$t_p=10ms, \sin 180^\circ, T_j=25^\circ C$	1200	$A^2S$

### Characteristics Values

Parameter	Symbol	Test Condition	Value			Unit	
			Min.	Typ.	Max.		
Forward voltage	$V_F$	$I_F=75A, V_{GE}=0V$ $I_F=75A, V_{GE}=0V$ $I_F=75A, V_{GE}=0V$	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$		2.05 1.7 1.6	V	
Peak reverse recovery current	$I_{RM}$	$I_F=60A,$ $-di_F/dt=800A/\mu s (T_{vj}=150^\circ C)$ $V_R=600V, V_{GE}=-15V$	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$		31 60 70	A	
Recovered charge	$Q_r$	$I_F=60A,$ $-di_F/dt=800A/\mu s (T_{vj}=150^\circ C)$ $V_R=600V, V_{GE}=-15V$	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$		5.1 11.8 14.1	$\mu C$	
Reverse recovered energy	$E_{rec}$	$I_F=60A,$ $-di_F/dt=800A/\mu s (T_{vj}=150^\circ C)$ $V_R=600V, V_{GE}=-15V$	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$		2.19 5 5.84	mJ	
Thermal resistance, junction to case	$R_{thJC}$	per diode				0.54	K/W
Temperature under switching conditions	$T_{vj\ op}$			-40		150	$^\circ C$

### Characteristics Values(Module)

Parameter	Symbol	Test Condition	Value	Unit	
Isolation test voltage	V <sub>ISOL</sub>	RMS, f=50Hz, t=1min	4000	V	
Internal isolation			Al <sub>2</sub> O <sub>3</sub>		
Storage temperature	T <sub>stg</sub>		-40	125	°C
Mounting torque for module mounting	M		3	5	Nm
Weight	W		163		g

### Typical Characteristics

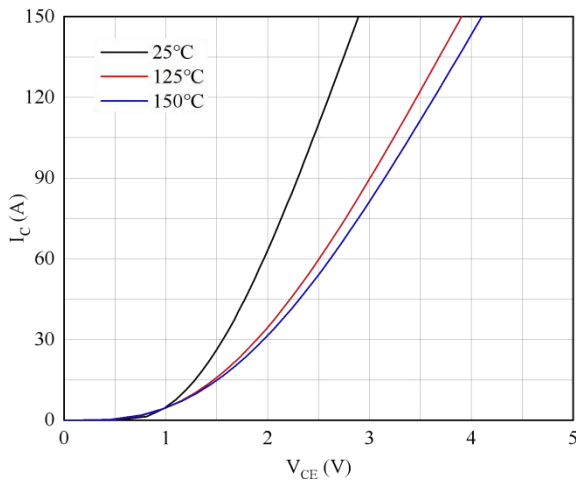


Fig 1. Typical output characteristics (V<sub>GE</sub>=15V)

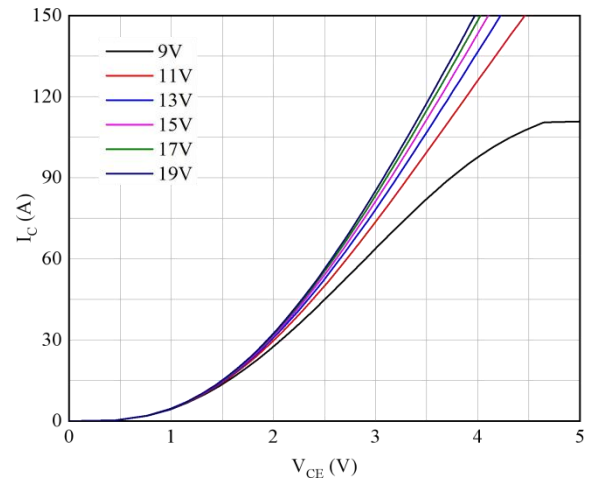


Fig 2. Typical output characteristics T<sub>vj</sub>=150°C

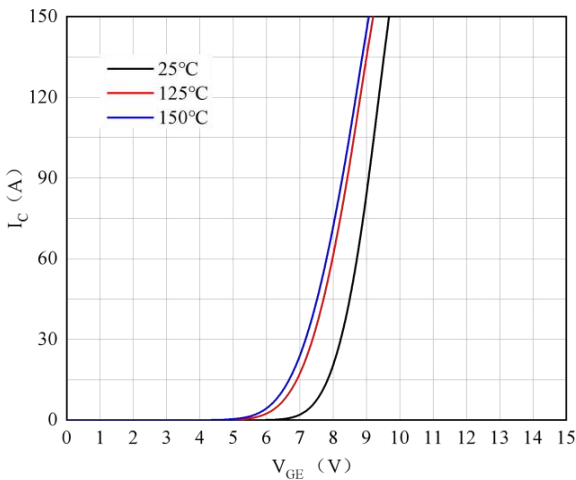


Fig 3. Typical transfer characteristic (V<sub>CE</sub>=20V)

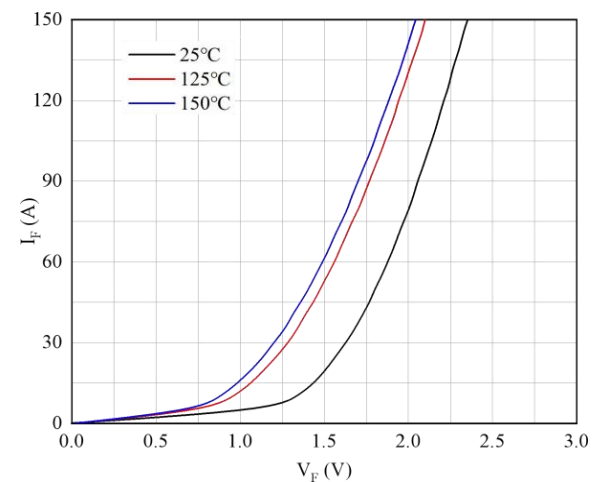


Fig 4. Forward characteristic of Diode

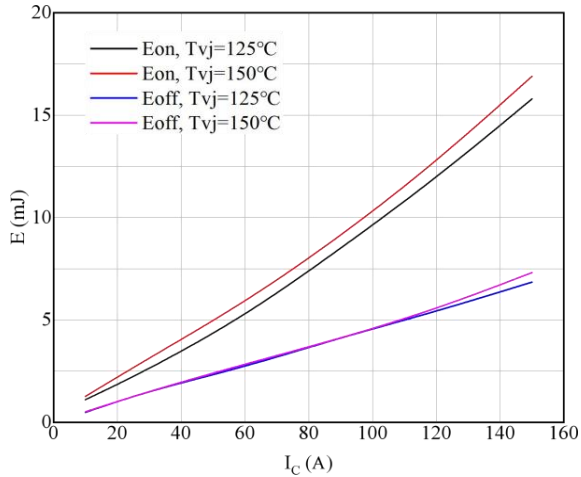


Fig 5. Switching losses of IGBT  
V<sub>GE</sub>=±15V, R<sub>Gon</sub>=15Ω, R<sub>Goff</sub>=15Ω, V<sub>CE</sub>=600V

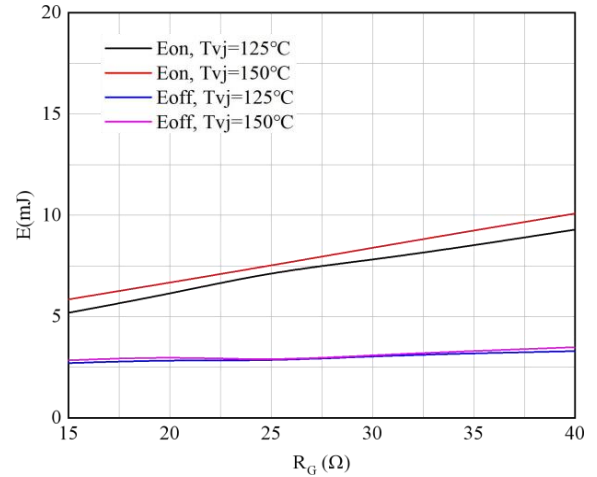


Fig 6. Switching losses of IGBT  
V<sub>GE</sub>=±15V, I<sub>C</sub>=60A, V<sub>CE</sub>=600V

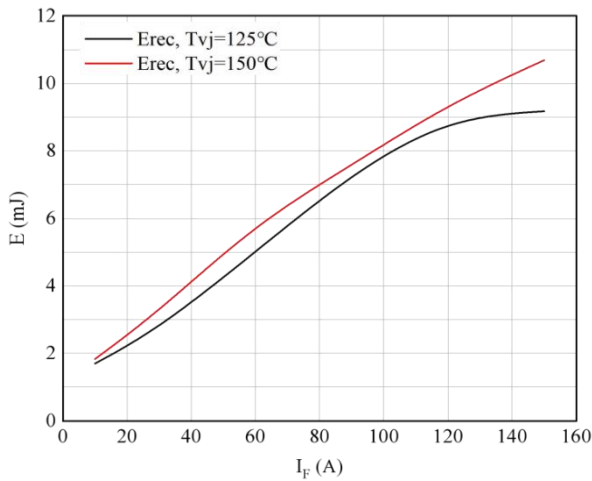


Fig 7. Switching losses of Diode  
R<sub>Gon</sub>=15Ω, V<sub>CE</sub>=600V

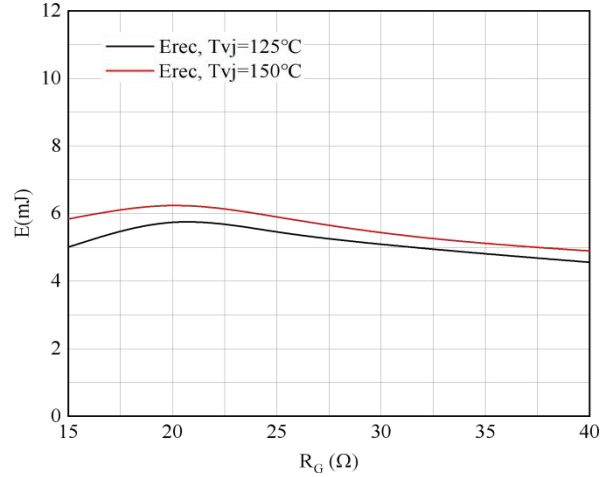


Fig 8. Switching losses of Diode  
I<sub>F</sub>=60A, V<sub>CE</sub>=600V

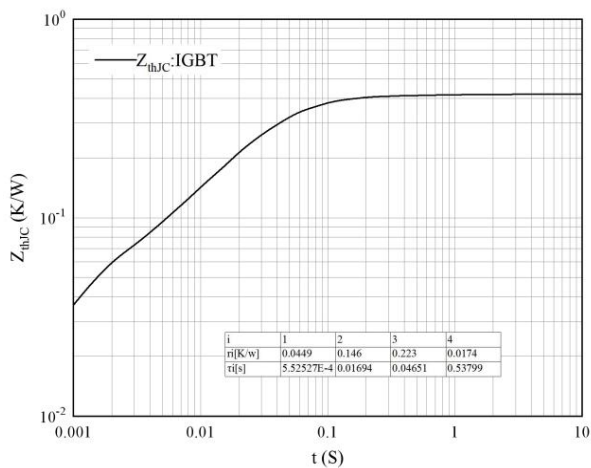


Fig 9. Transient thermal impedance IGBT, Inverter  
Z<sub>thJC</sub>=f(t)

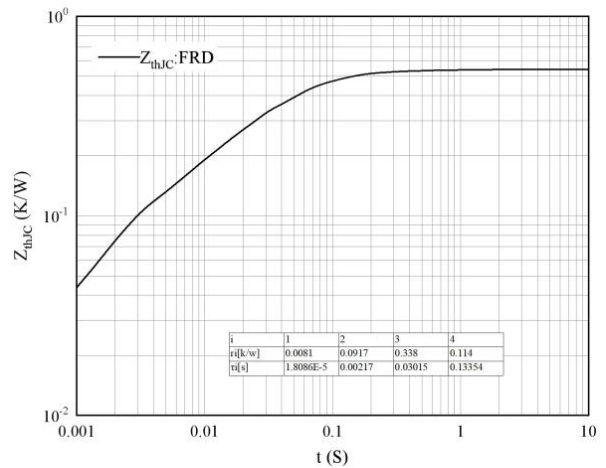


Fig 10. Transient thermal impedance FRD, Inverter  
Z<sub>thJC</sub>=f(t)

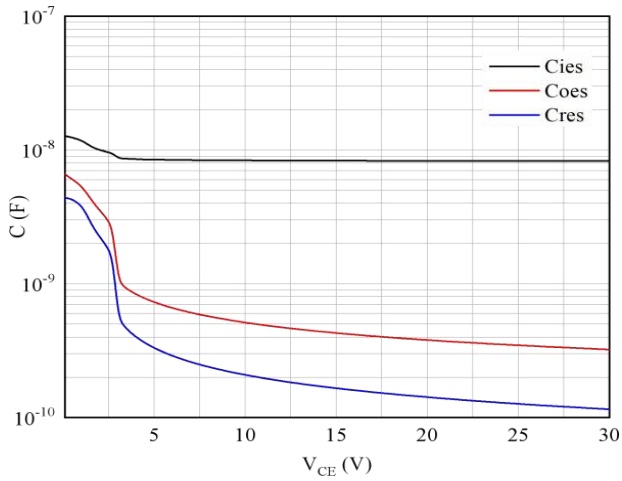
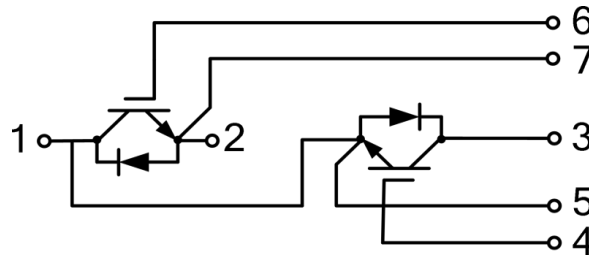
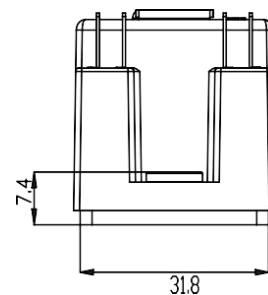
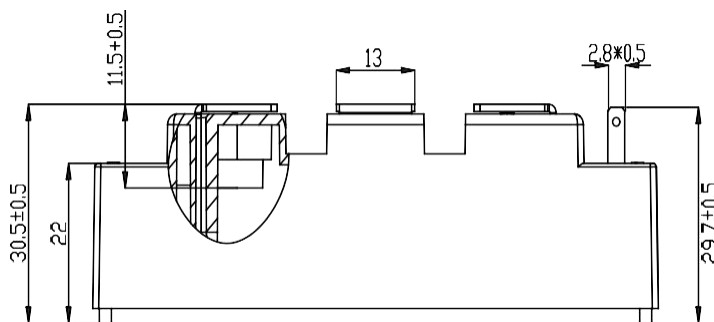
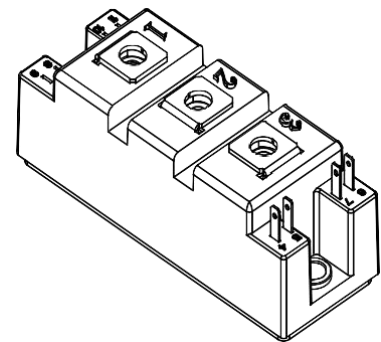
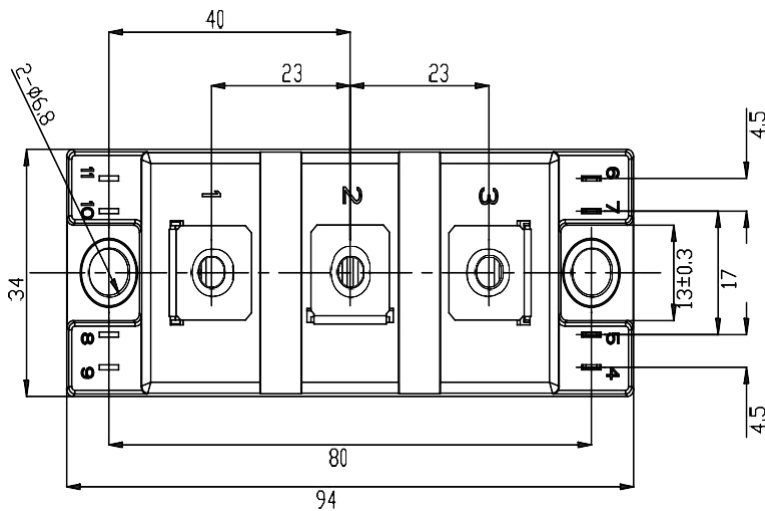


Fig 11. Capacitance characteristic

**Circuit Diagram**



**Package Outlines (Unit: mm)**



**\*Important Usage Information and Disclaimer**

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